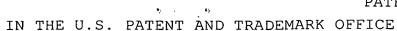
PATENT APPLICATION



Applicant(s): Katsuyuki TSUCHIDA et al

Title : COPPER ELECTROLYTIC SOLUTION CONTAINING AS ADDITIVE

COMPOUND HAVING SPECIFIC SKELETON, AND

ELECTROLYTIC COPPER FOIL MANUFACTURED THEREWITH

Serial No. : 10/588 686 Group: 1795

Confirmation No.: 9917

Filed : August 7, 2006 Examiner: Wong International Application No.: PCT/JP2005/022662
International Filing Date : December 9, 2005

Atty. Docket No.: 4700.P0335US

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

FIRST CLASS MAILING CERTIFICATE

Sir:

I hereby certify that this correspondence is being deposited with the United States Postal Service under 37 CFR 1.8 as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on January 20, 2009.

Terryence F. Chapman

TFC/ad

FLYNN, THIEL, BOUTELL David G. Boutell Reg. No. 25 072 & TANIS, P.C. Terryence F. Chapman Reg. No. 32 549 2026 Rambling Road Mark L. Maki Req. No. 36 589 Reg. No. 40 694 Kalamazoo, MI 49008-1631 Liane L. Churney Reg. No. 24 802 Phone: (269) 381-1156 John A. Waters (269) 381-5465 Brian R. Tumm Donald J. Wallace Fax: Reg. No. 36 328 Reg. No. 43 977 Dale H. Thiel Reg. No. 24 323 Sidney B. Williams, Jr. Reg. No. 24 949 Heon Jekal Reg. No. L0379* *limited recognition number

Correspondence: Supplemental Information Disclosure Statement dated

January 20, 2009 including enclosures listed

thereon

190.05/05



IN THE U.S. PATENT AND TRADEMARK OFFICE

January 20, 2009

Applicant(s): Katsuyuki TSUCHIDA et al

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COMPOUND HAVING SPECIFIC SKELETON, AND ELECTROLYTIC

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Alexandria, VA 22313-1450

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Sir:

In compliance with the provisions of Rules 1.97(b)(3) and 1.98, enclosed herewith is a copy of a Japanese language Office Action issued in a corresponding application not more than three months prior to filing of this Information Disclosure Statement, Form PTO-1449 and a copy of a foreign reference cited thereon.

Further comment at this point in time should not be necessary.

Further consideration is respectfully solicited.

Respectfully submitted,

Terryence F. Chapman

TFC/ad

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	Heon Jekal	Reg.	No.	L0379*
	*limited recognition number			

Encl: Form PTO-1449

Copy of Japanese language Office Action One copy of cited foreign reference

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Terryepice F. Chapman

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